

MBR130HW SURFACE MOUNT SCHOTTKY BARRIER DIODE

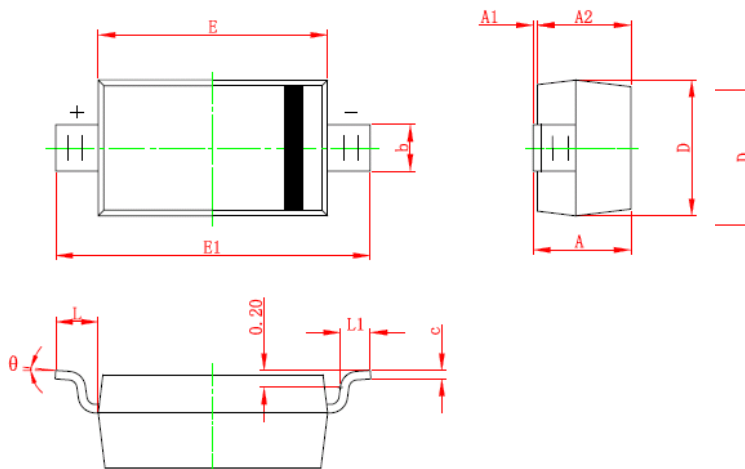
Features:

- Low Turn-on Voltage
- Fast Switching
- PN Junction Guard Ring Transient and ESD Protection
- Designed for Surface Mount Application
- Plastic Material —UL Recognition Flammability Classification 94V-0
- Green Products in Compliance with the ROHS Directive
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Data:

- Case: SOD-123, Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Weight: 0.01 grams(approx)

Mechanical Dimensions: In mm / Inches

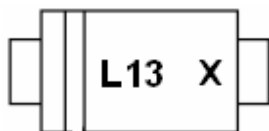


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.450	0.650	0.018	0.026
c	0.080	0.150	0.003	0.006
D	1.500	1.700	0.059	0.067
E	2.600	2.800	0.102	0.110
E1	3.550	3.850	0.140	0.152
L	0.500 REF		0.020 REF	
L1	0.250	0.450	0.010	0.018
θ	0°	8°	0°	8°

SOD-123(CJ)



Marking Diagram:



Where X is Date Code

L13 = Part Name

Cautions: Molding resin
Epoxy resin UL:94V-0

Ordering Information:

Device	Package	Shipping
MBR130HW	SOD-123(Pb-Free)	3000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.



Maximum Ratings @T_A=25°C unless otherwise specified

Characteristic	Symbol	MBR130HW	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	VRRM VRWM VR	30	V
Forward Continuous Current (Note 1)	IF	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	IFSM	25	A
Power Dissipation (Note 1)	Pd	450	mW
Typical Thermal Resistance, Junction to Ambient Air (Note 1)	R _{θJA}	222	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +125	°C

Electrical Characteristics @T_A=25°C unless otherwise specified

Characteristic	Symbol	MBR130HW	Unit
Forward Voltage Drop @IF = 1.0A	VFM	0.45	V
Peak Reverse Leakage Current @ DC Blocking Voltage	IRM	0.4	mA
Typical Junction Capacitance (V _R = 4V DC, f = 1MHz)	C _J	50	pF

Note: 1. Valid provided that terminals are kept at ambient temperature.

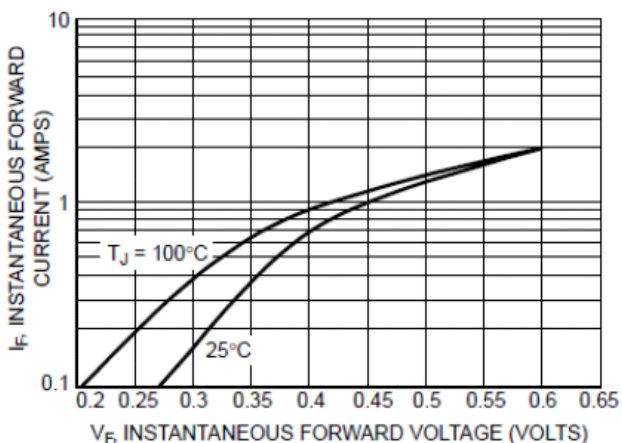


Figure 1. Maximum Forward Voltage

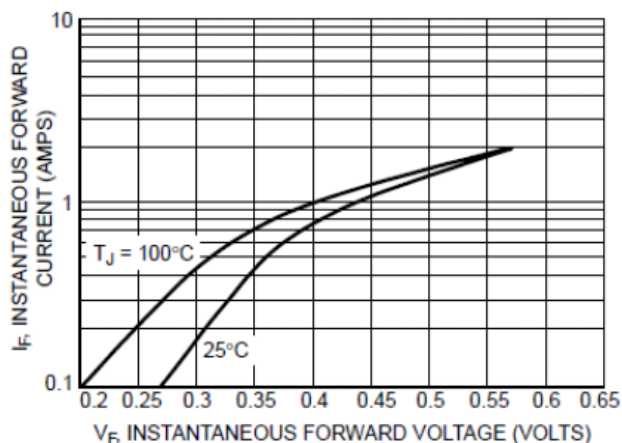


Figure 2. Typical Forward Voltage

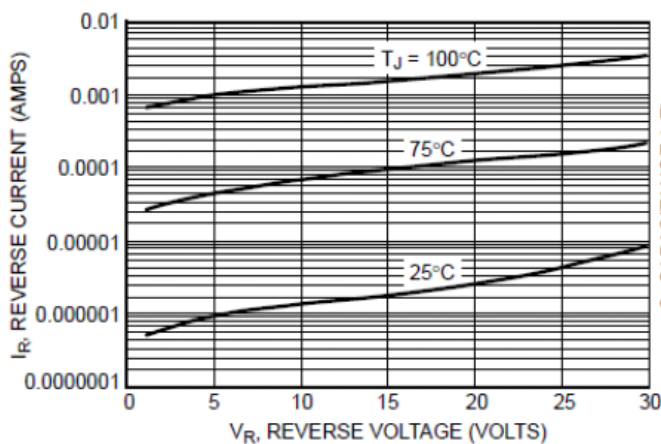


Figure 3. Typical Reverse Current

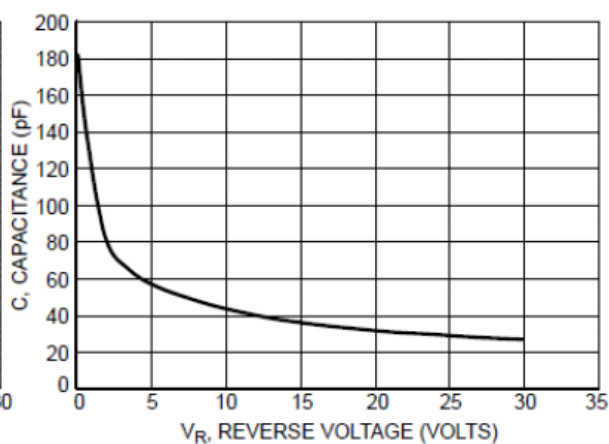


Figure 4. Typical Capacitance



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